

# INTERNATIONAL GEMOLOGICAL INSTITUTE

## LABORATORY GROWN DIAMOND REPORT

### IGI LABORATORY GROWN DIAMOND IDENTIFICATION REPORT

July 2, 2022	
IGI Report Number	LG536203742
Description	LABORATORY GROWN DIAMOND
Shape and Cutting Style	CUT CORNERED RECTANGULAR MODIFIED BRILLIANT
Measurements	6.83 X 4.94 X 3.21 MM
GRADING RESULTS	
Carat Weight	0.91 CARAT

Carat Weight	0.91 CARA
Color Grade	D
Clarity Grade	VS 1

## ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	LABGROWN IGI LG536203742
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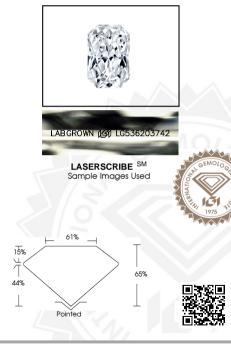
Comments: As Grown - No indication of post-growth treatment. This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

## ELECTRONIC COPY

Thick

## LABORATORY GROWN DIAMOND REPORT

## LG536203742



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For terms & conditions and to verify this report, please visit www.igi.org

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